

## Headphone Amplifiers

# Standard Headphone Amplifiers


**BH3544F, BH3547F, BH3548F**

No.15102EDT02

**●Description**

BH3544F, BH3547F, BH3548F are headphone amplifiers suitable for portable products. BH3544F, BH3547F, BH3548F has a fixed gain of 6 dB. External resistors for gain setting are not needed. Package of BH3544F, BH3547F, BH3548F is pin-to-pin compatible (SOP8), enable to replace each other easily.

BH3544F, BH3547F, BH3548F also has mute functions that make it easy to prevent pop noise when power supply turns on/off. Moreover, thermal shutdown function is built-in. BH3544F, BH3547F can drive 16/32Ω load, BH3548F can drive 8/16/32Ω. So, BH3548F is suitable for 8Ω receiver.

**●Features**

- 1) Built-in mute function for preventing pop noise when power supply turns on/off
- 2) Built-in thermal shutdown function
- 3) BH3544F, BH3547F, BH3548F are pin-to-pin compatible
- 4) SOP8 small package

**●Applications**

TV, Desktop PC, Notebook PC, Camcorder and other equipment having headphone output

**●Line up**

Part No.	BH3544F	BH3547F	BH3548F	Unit
Supply voltage	+2.8 ~ +6.5	+4.5 ~ +6.5	+4.0 ~ +5.5	V
Quiescent current	7.0	3.7	6.5	mA
Amplifier gain	6			dB
Output [RL=16Ω]	62	77	62	mW
load impedance	16 / 32		8/16/32	Ω
Operating temperature range	-25 ~ +75		-40 ~ +85	°C

**●Absolute maximum ratings(Ta=25°C)**

Parameter	Symbol	Ratings	Unit
		BH3544F, BH3547F, BH3548F	
Applied voltage	VCC	7.0	V
Power dissipation	Pd	550 <sup>*1</sup>	mW
Storage temperature	Tstg	-55~+125	°C

\*1 Derating is done at 5.5mW/°C above Ta=25°C. (When mounted on a 70mm×70mm×1.6mm PCB board, FR4)

**●Operating conditions (Ta=25°C)**

Parameter	Symbol	Limits			Unit
		BH3544F	BH3547F	BH3548F	
Supply voltage	VCC	+2.8 ~ +6.5	+4.5 ~ +6.5	+4.0 ~ +5.5	V
Temperature Range	Topr	-25~+75		-40 ~ +85	°C

\* These product are not designed for protection against radioactive rays.

●Electrical characteristics (Unless otherwise noted, Ta=25°C, VCC=5V, RL=32Ω, f=1kHz, BW=400~30kHz, VIN = -6dBV)

Parameter	Symbol	Limits(TYP.)			Unit	Conditions
		BH3544F	BH3547F	BH3548F		
Quiescent current	I <sub>Q</sub>	7	3.7	6.5	mA	V <sub>IN</sub> =0Vrms
Mute pin control voltage H	V <sub>TMH</sub>	1.6<			V	Mute OFF
Mute pin control voltage L	V <sub>TML</sub>	<0.3			V	Mute ON
Gain	G <sub>VC</sub>	6			dB	-
Gain difference between channels	ΔG <sub>VC</sub>	0			dB	-
Total harmonic distortion	THD	0.02	0.05	0.02	%	BW=20~20kHz
Rated output 1	P <sub>O1</sub>	31	46	31	mW	RL=32Ω, THD<0.1% (BH3541F, BH3544F, BH3548F) RL=32Ω, THD<0.3% (BH3547F)
Rated output 2	P <sub>O2</sub>	62	77	62	mW	RL=16Ω, THD<0.1% (BH3541F, BH3544F, BH3548F) RL=16Ω, THD<0.5% (BH3547F)
Rated output 3	P <sub>O3</sub>	-		120	mW	RL=8Ω, THD<0.25% (BH3548F)
Output noise voltage	V <sub>NO</sub>	-93			dBV	BW=20~20kHz, R <sub>g</sub> =0Ω
Channel separation	CS	-90	-87	-90	dB	R <sub>g</sub> =0Ω
Mute attenuation	ATT	-80			dB	R <sub>g</sub> =0Ω
Ripple rejection	RR	-57			dB	f <sub>RR</sub> =100Hz, V <sub>RR</sub> =-20dBV
Input resistance	R <sub>IN</sub>	90			kΩ	-

●Reference data

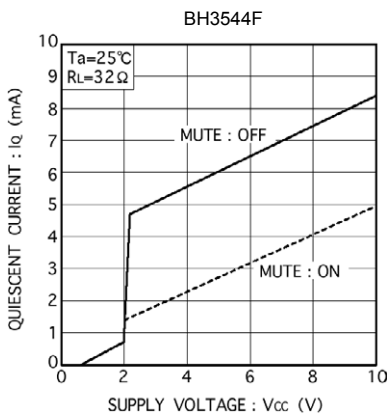


Fig. 1 Quiescent current vs. power supply voltage

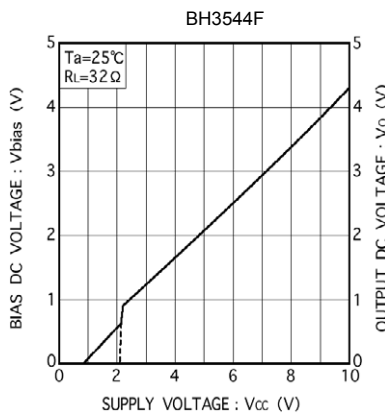


Fig. 2 in DC current vs. power supply voltage

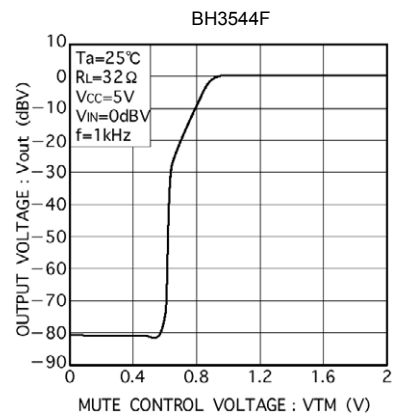


Fig. 3 Output voltage vs. Mute control voltage

●Reference data (Continued)

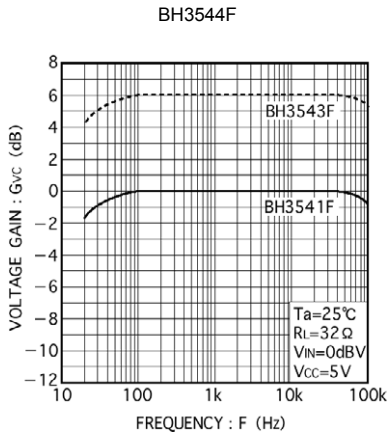


Fig. 4 Voltage gain vs. frequency

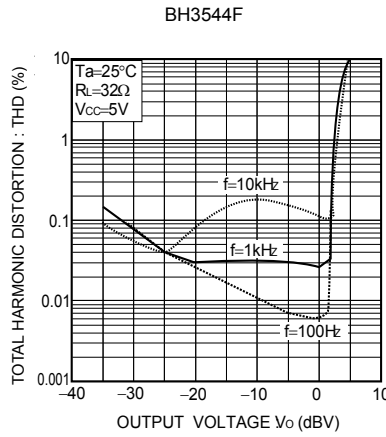


Fig. 5 Total harmonic distortion vs. output voltage (1)

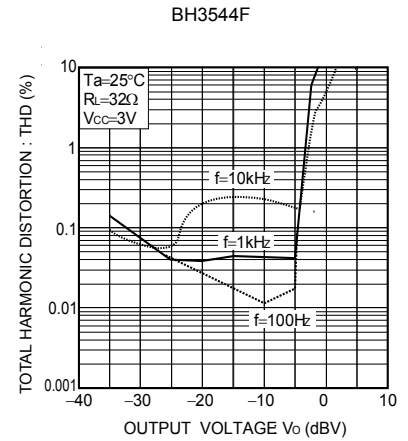


Fig. 6 Total harmonic distortion vs. output voltage (2)

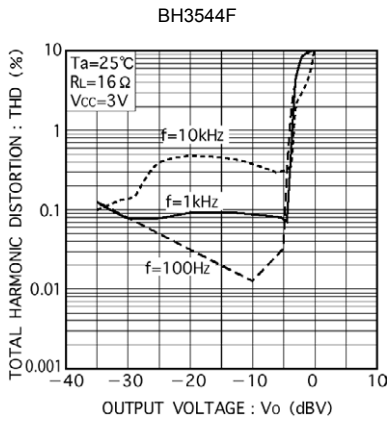


Fig. 7 Total harmonic distortion vs. output voltage (3)

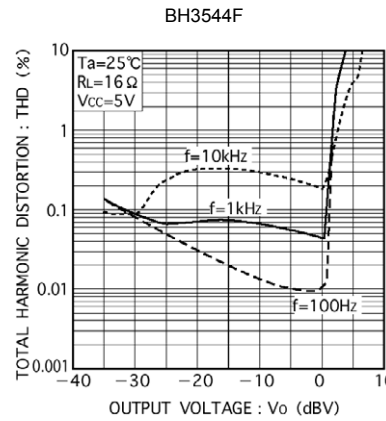


Fig. 8 Total harmonic distortion vs. output voltage (4)

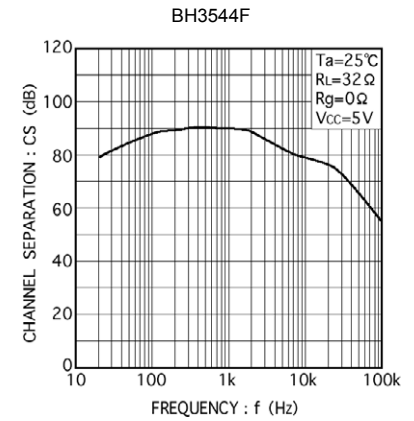


Fig. 9 Channel separation vs. frequency

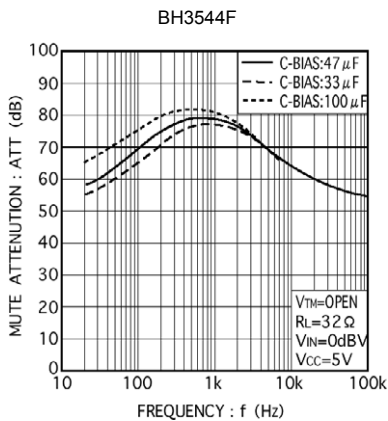


Fig. 10 MUTE attenuation vs. frequency

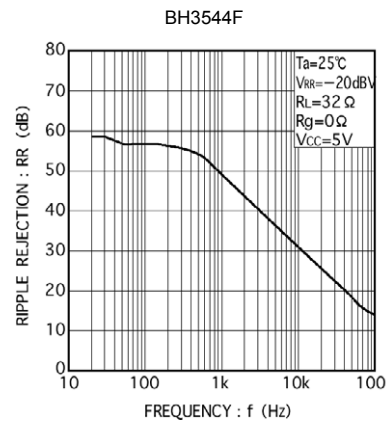


Fig. 11 Ripple rejection vs. frequency

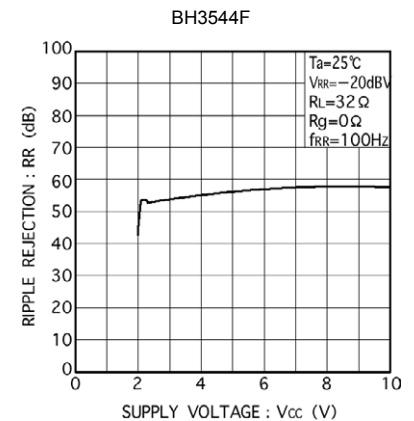


Fig. 12 Ripple rejection vs. power supply voltage

●Block diagram

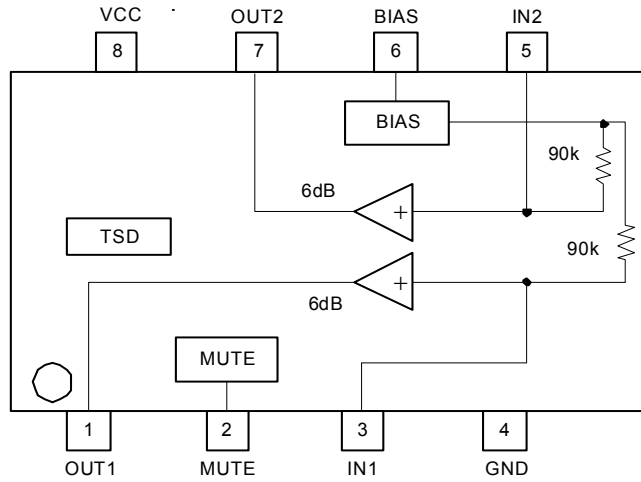


Fig. 13

●Measurement circuit

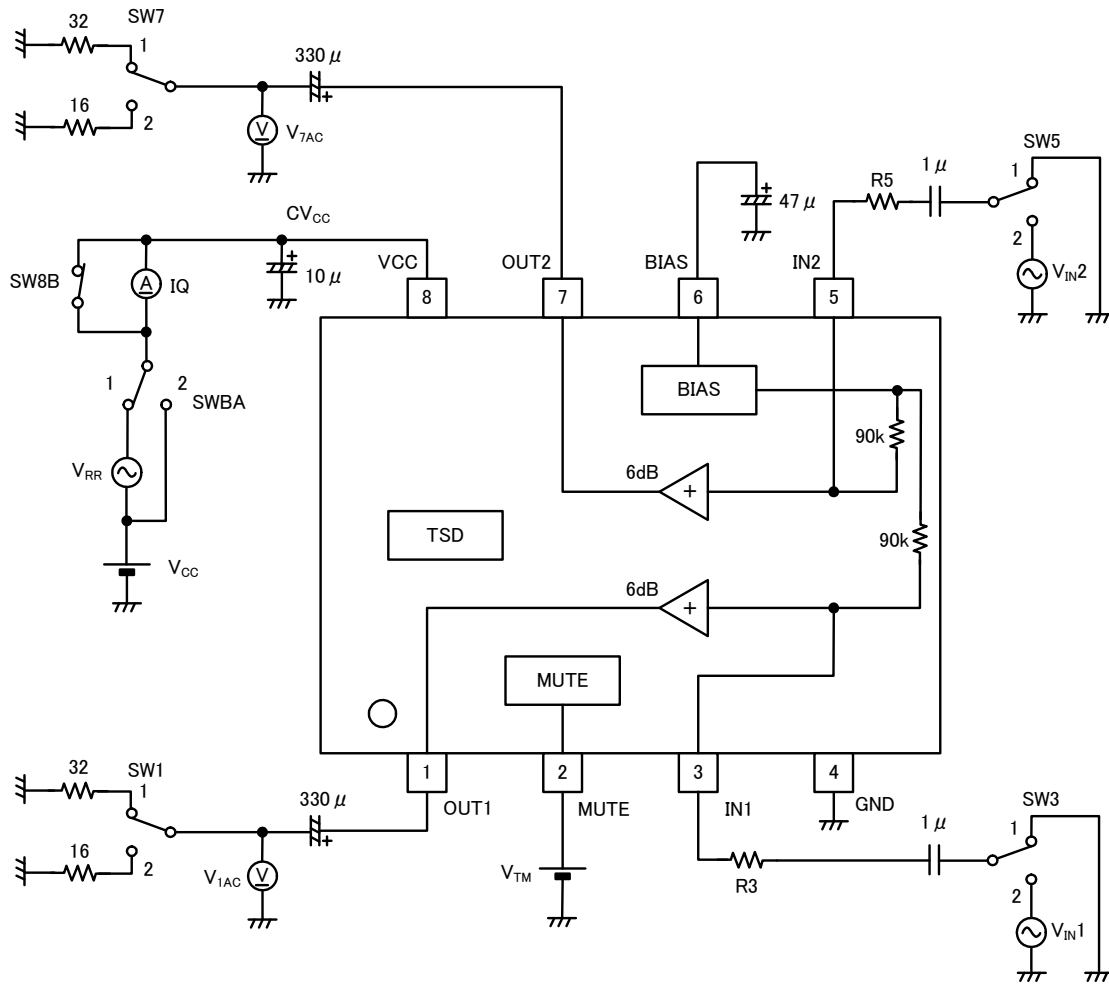
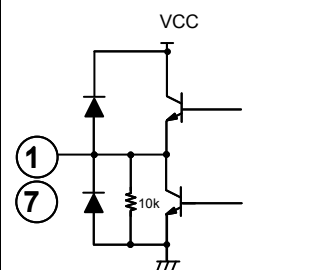
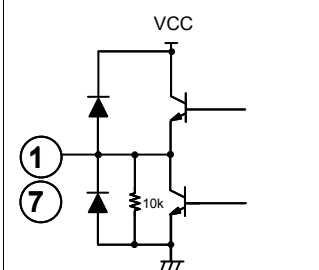
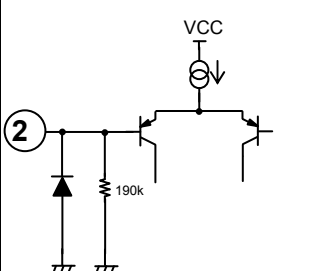
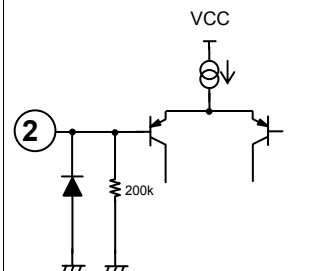
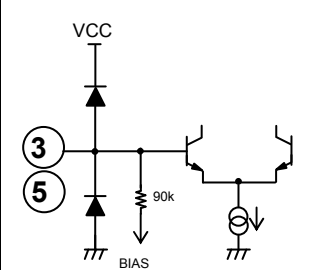
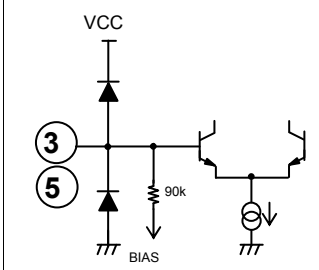
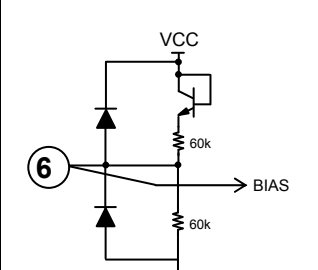
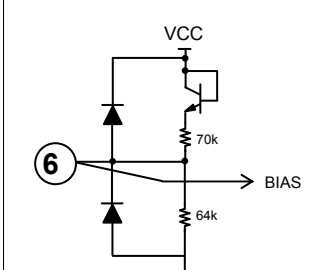


Fig. 14

•Terminal Equivalent Circuit / Description

Pin No.	Pin Name	I/O	Pin voltage	Equivalent circuit		Function
				BH3544F, BH3548F	BH3547F	
1 7	OUT1 OUT2	O	2.1V (VCC=5V)			Output pin
2	MUTE	I	0.1V (When open)			Mute control pin Active:Hi Mute:Lo (open)
3 5	IN1 IN2	I	2.1V (VCC=5V)			Input pin
6	BIAS	I/O	2.1V (VCC=5V)			Bias pin  (Since the 47 μF externally attached capacitor also serves as the time constant for pop noise countermeasures, evaluate adequately when changing it.)
4	GND	I	-	-	-	GND pin
8	VCC	I	-	-	-	Power supply pin

※The figure in the pin explanation and input/output equivalent circuit is reference value, it doesn't guarantee the value.

### ● Application circuit

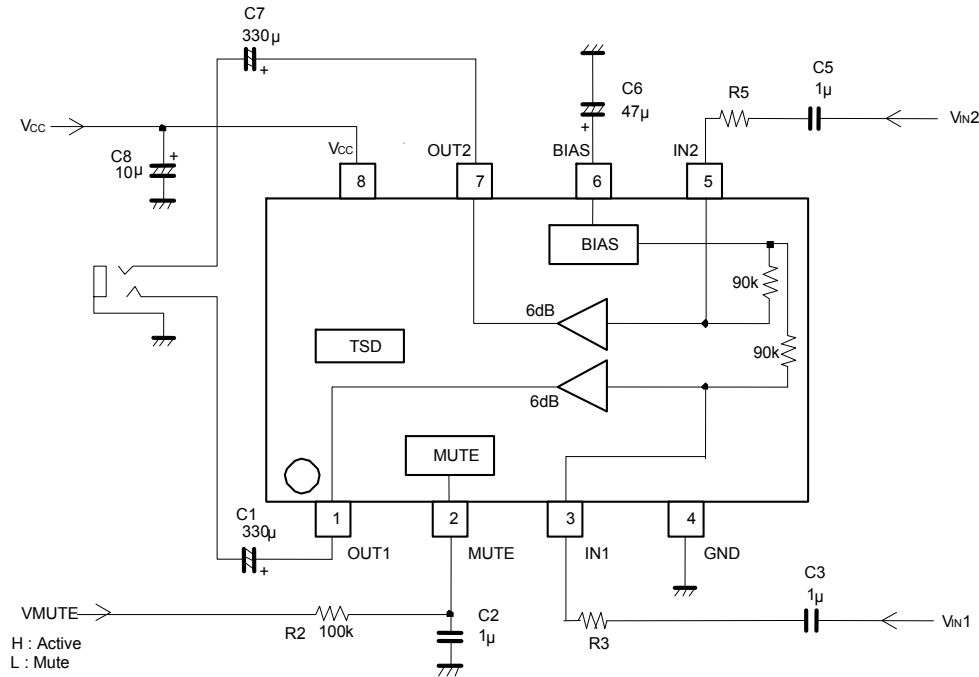


Fig. 15

### ● Description of external components

#### 1) Input coupling capacitors (C3, C5)

These are determined according to the lower cutoff frequency  $f_c$ . Moreover, since lowering the capacitance can cause the occurrence of pop noise, when changing this, determine it after adequate checking.

Since the input impedance is  $90\text{k}\Omega$ , these are found by the expressions below, although drift, temperature characteristics, and other considerations are necessary. (Layered ceramic capacitors are recommended.)

$$C3(C5) = 1 / (2\pi \times 90\text{k}\Omega \times f_c)$$

#### 2) Bias capacitor (C6)

When  $V_{CC}=5\text{V}$ ,  $47\mu\text{F}$  is recommended. Since lowering the capacitance too much can cause worsening of electrical characteristics or the occurrence of pop noise, when changing this, determine it after checking this adequately.

#### 3) Mute pin pop noise countermeasures (R2, C2)

Since BH3544F, BH3548F have an impedance of  $190\text{k}\Omega$  against GND and the BH3547F has  $200\text{k}\Omega$ , it may be impossible to cancel mute mode if R2 is made too large.

#### 4) Output coupling capacitors (C1, C7)

These are determined by the lower cutoff frequency. If  $R_L$  is the output load resistance (assuming a resistance  $R_x$  is put in for output protection or current restriction), these are found by the expression below.

$$C1(C7) = 1 / (2\pi \times (R_L + R_x) \times f_c)$$

#### 5) Input gain adjustment resistances (R3, R5)

Externally attached resistances (R3, R5) make input gain adjustment possible. The gain found by the expression below can be set.

$$G_{VC} = 6 + 20 \log(90\text{k}\Omega / (90\text{k}\Omega + R3[R5])) \text{ [dB]}$$

When input gain is not accommodated, these resistors have no use.

● Notes for use

- 1) Numbers and data in entries are representative design values and are not guaranteed values of the items.
- 2) Although we are confident in recommending the sample application circuits, carefully check their characteristics further when using them. When modifying externally attached component constants before use, determine them so that they have sufficient margins by taking into account variations in externally attached components and the Rohm LSI, not only for static characteristics but also including transient characteristics.
- 3) Absolute maximum ratings  
If applied voltage, operating temperature range, or other absolute maximum ratings are exceeded, the LSI may be damaged. Do not apply voltages or temperatures that exceed the absolute maximum ratings. If you think of a case in which absolute maximum ratings are exceeded, enforce fuses or other physical safety measures and investigate how not to apply the conditions under which absolute maximum ratings are exceeded to the LSI.
- 4) GND potential  
Make the GND pin voltage such that it is the lowest voltage even when operating below it. Actually confirm that the voltage of each pin does not become a lower voltage than the GND pin, including transient phenomena.
- 5) Thermal design  
Perform thermal design in which there are adequate margins by taking into account the allowable power dissipation in actual states of use.
- 6) Shorts between pins and misinstallation  
When mounting the LSI on a board, pay adequate attention to orientation and placement discrepancies of the LSI. If it is misinstalled and the power is turned on, the LSI may be damaged. It also may be damaged if it is shorted by a foreign substance coming between pins of the LSI or between a pin and a power supply or a pin and a GND.
- 7) Operation in strong magnetic fields  
Adequately evaluate use in a strong magnetic field, since there is a possibility of malfunction.
- 8) Pop noise countermeasures  
In order to prevent the pop noise that occurs when the power supply turns ON or OFF, make the rise and fall with reference to the timing diagram shown below.

1) BH3544F/ BH3548F

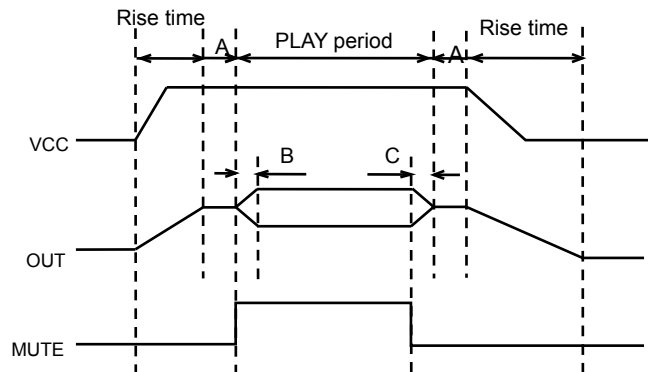


Fig. 16

- (A): Mute period (Use as pop noise countermeasure when power supply turns ON/OFF by making VMUTE=Lo.)
- (B): Mute cancellation period (This has a time constant because it is used by the externally attached C2 and R2 as a pop noise countermeasure on mute cancellation, so be careful of the timing.)
- (C): Mute start time (As on cancellation, this has a time constant.)

2) BH3547F

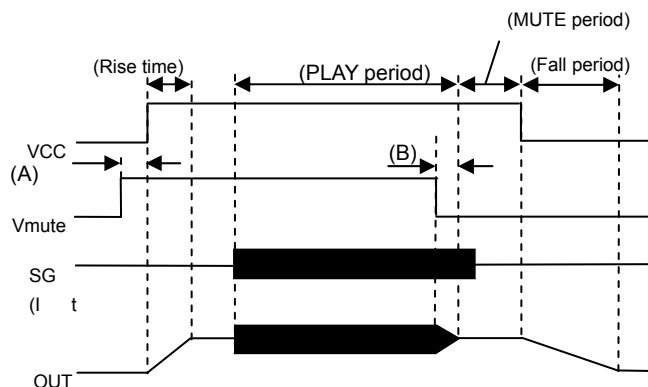


Fig. 17

- (A): Before VCC rise (or at the same time as VCC) make mute cancelled (VMUTE=Hi).
- (B): Soft mute period (This time can be set by externally attached R2 and C2)

● Ordering part number

B	H
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Part No.

3	5	4	4
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Part No.

3544  
3547  
3548

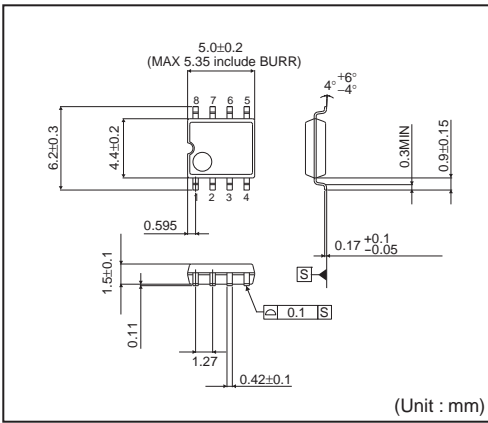
F
---

Package  
F: SOP8

E	2
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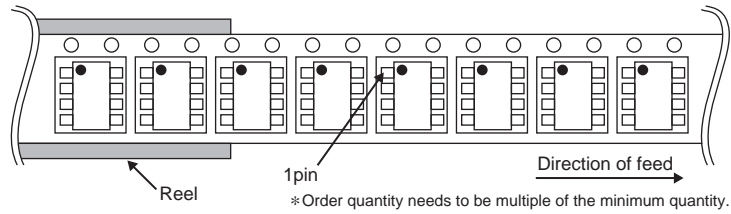
Packaging and forming specification  
E2: Embossed tape and reel

SOP8



<Tape and Reel information>

Tape	Embossed carrier tape
Quantity	2500pcs
Direction of feed	E2 (The direction is the 1pin of product is at the upper left when you hold reel on the left hand and you pull out the tape on the right hand )





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CLASS IV		CLASS III	

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  - Sealing or coating our Products with resin or other coating materials
  - Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - Use of the Products in places subject to dew condensation
- The Products are not subject to radiation-proof design.
- Please verify and confirm characteristics of the final or mounted products in using the Products.
- In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
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- Confirm that operation temperature is within the specified range described in the product specification.
- ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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- When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

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1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
  - [a] the Products are exposed to sea winds or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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